



Technical Data Sheet

Right Angle Lens Chip LEDs with Bi-Color(Multi-Color)

12-22SURSUGC/S530-A3/TR8

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multicolor type.
- Pb-free.
- The product itself will remain within RoHS compliant version.



Descriptions

- The 12-22 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

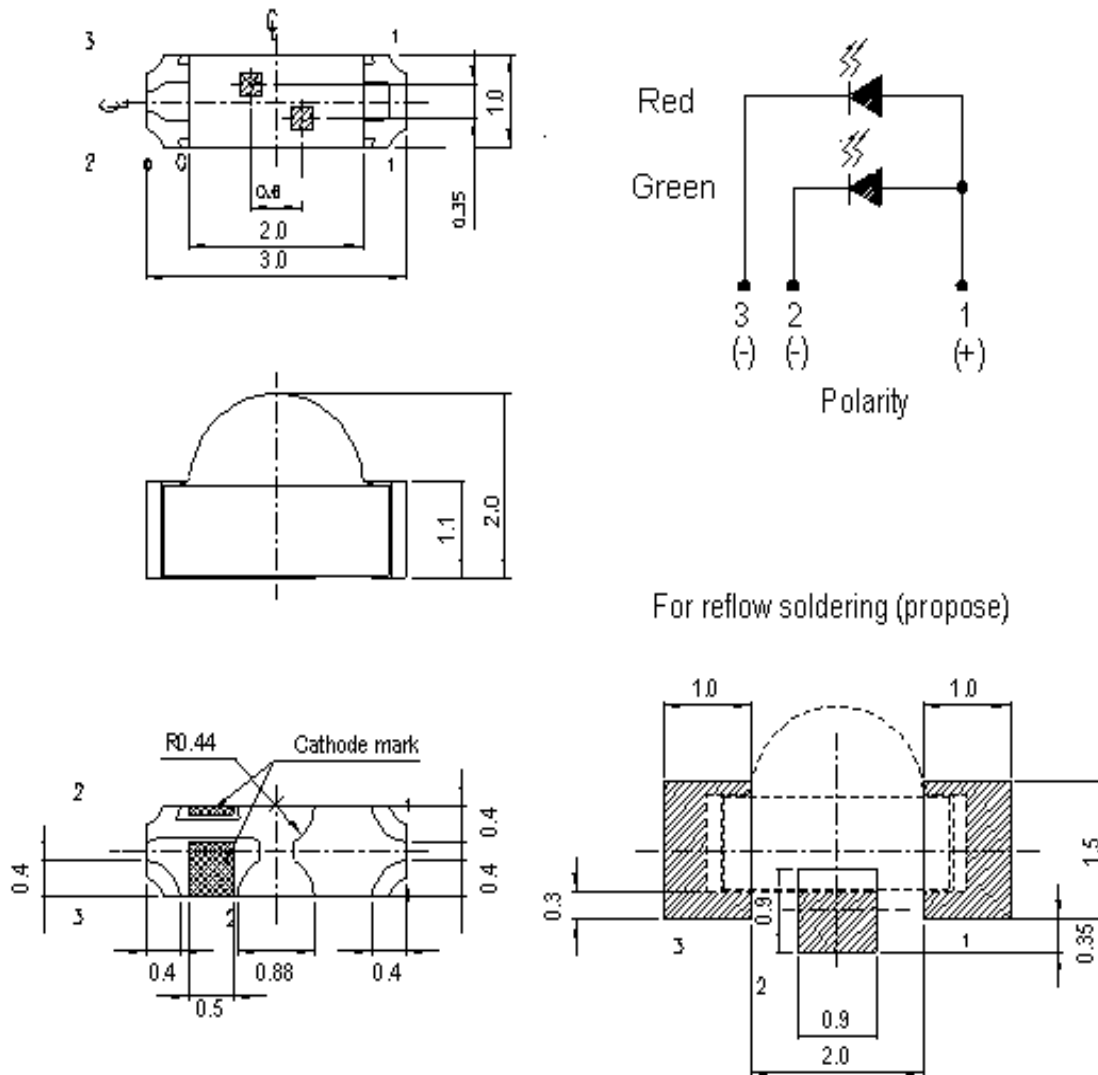
- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Chip		Emitted Color	Resin Color
Type	Material		
SUR	AlGaInP	Brilliant Red	Water Clear
SUG	AlGaInP	Brilliant Green	

12-22SURSUGC/S530-A3/TR8

Package Outline Dimensions



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

**Absolute Maximum Ratings (Ta=25)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	R6:25 G6:25	mA
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	R6:60 GH:100	mA
Power Dissipation	P _d	R6:60 G6:95	mW
Electrostatic Discharge(HBM)	ESD	R6:2000 G6:150	V
Operating Temperature	T _{opr}	-40 ~ +85	
Storage Temperature	T _{stg}	-40~ +90	
Soldering Temperature	T _{sol}	Reflow Soldering : 260 for 10 sec. Hand Soldering : 350 for 3 sec.	

CONFIDENTIAL

12-22SURSUGC/S530-A3/TR8

Electro-Optical Characteristics (Ta=25)

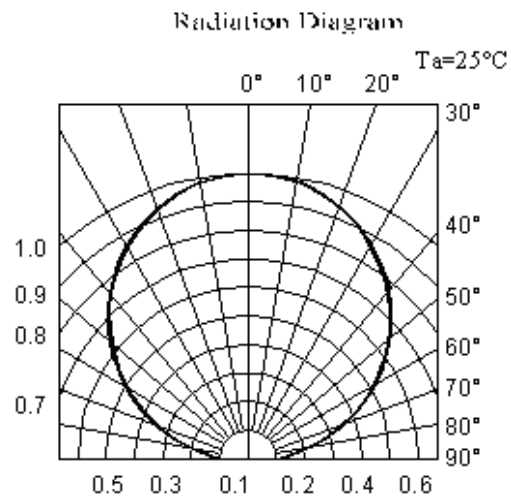
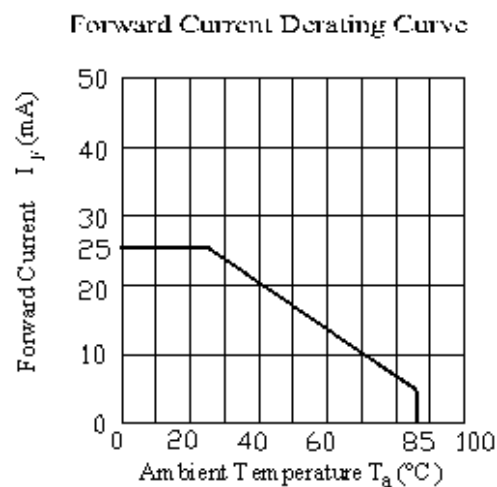
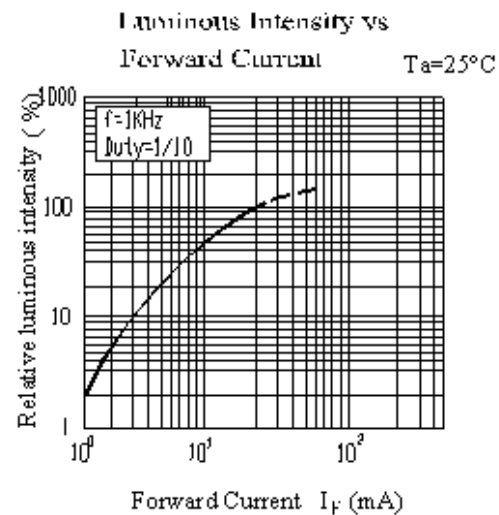
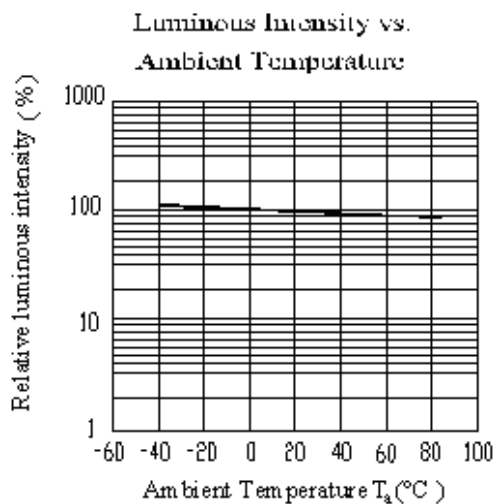
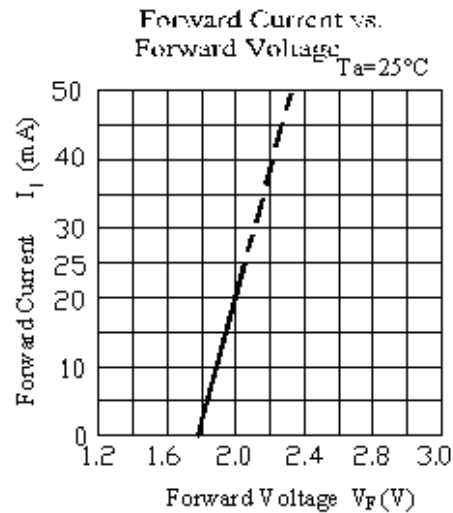
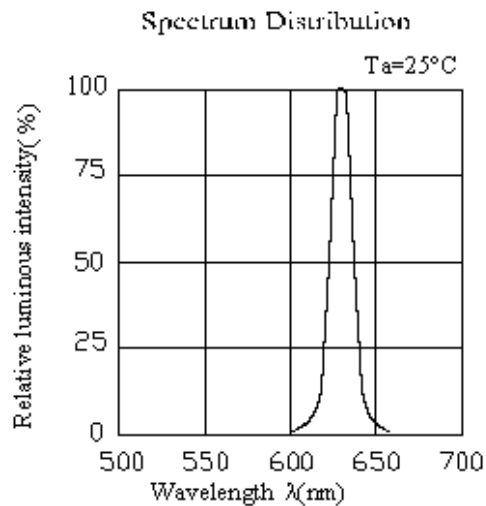
Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I _v SUR	45	68	-----	mcd	I _F =20mA
	SUG	100	210	-----		
Viewing Angle	2 θ 1/2	-----	120	-----	deg	
Peak Wavelength	λ _p SUR	-----	632	-----	nm	
	SUG		518			
Dominant Wavelength	λ _d SUR	-----	624	-----	nm	
	SUG		525			
Spectrum Radiation Bandwidth	λ SUR	-----	20	-----	nm	
	SUG		35			
Forward Voltage	V _F SUR	1.7	2.0	2.4	V	
	SUG	2.7	3.3	3.7		
Reverse Current	I _R SUR	-----	-----	10	μ A	V _R =5V
	SUG			50		

Notes:

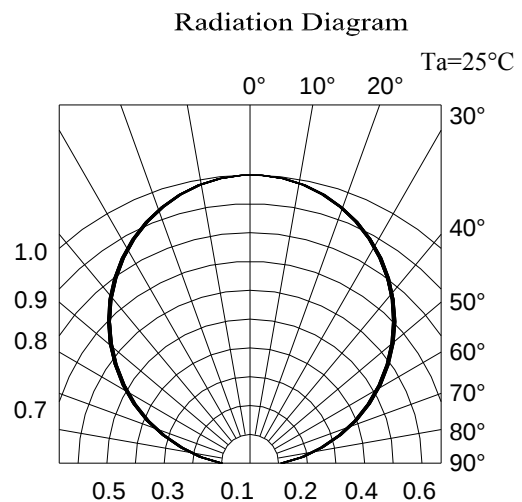
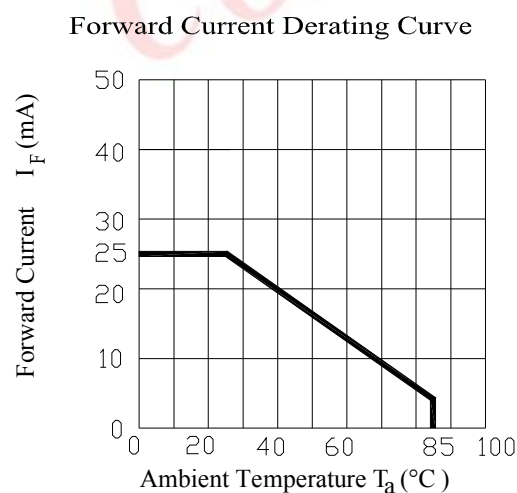
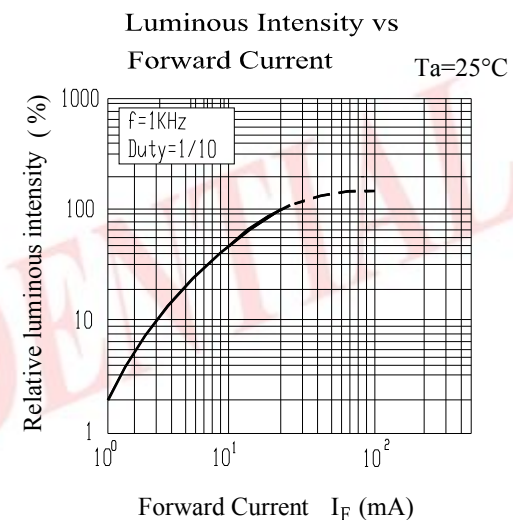
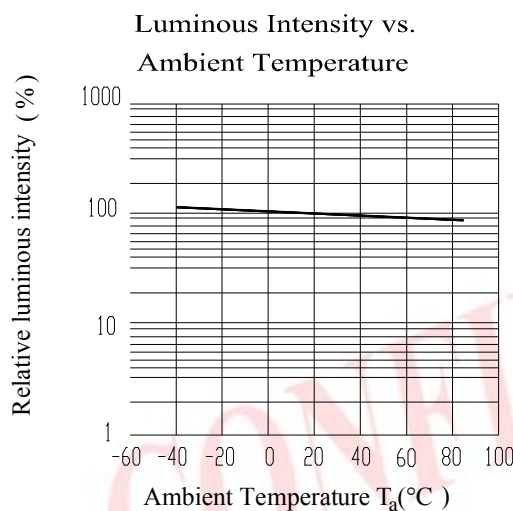
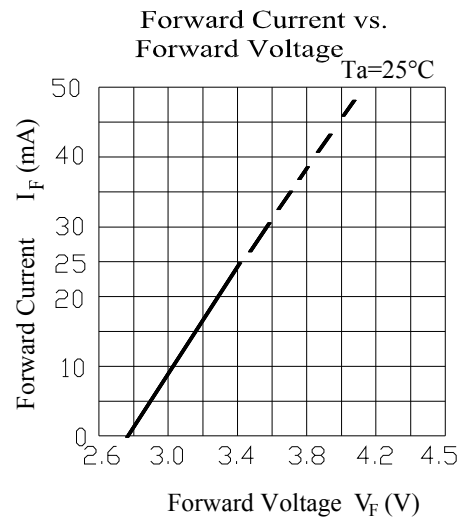
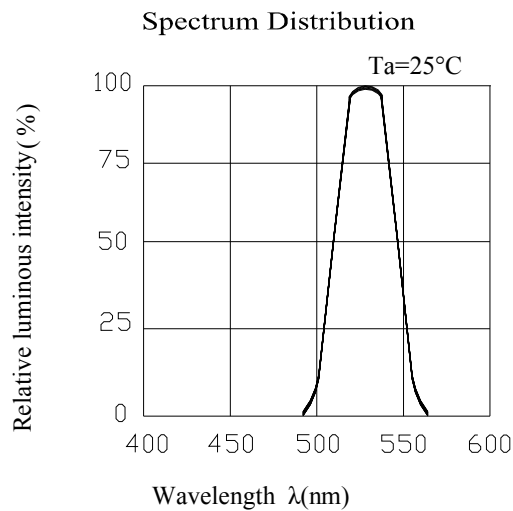
1.Tolerance of Luminous Intensity ±11%

CONFIDENTIAL

Typical Electro-Optical Characteristics Curves SUR



Typical Electro-Optical Characteristics Curves SUG

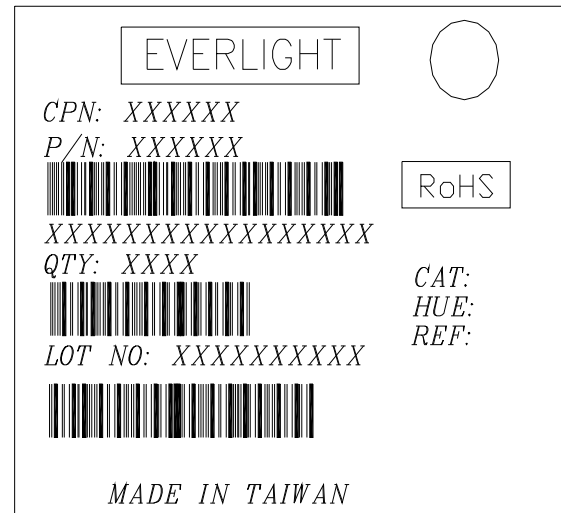


Label explanation

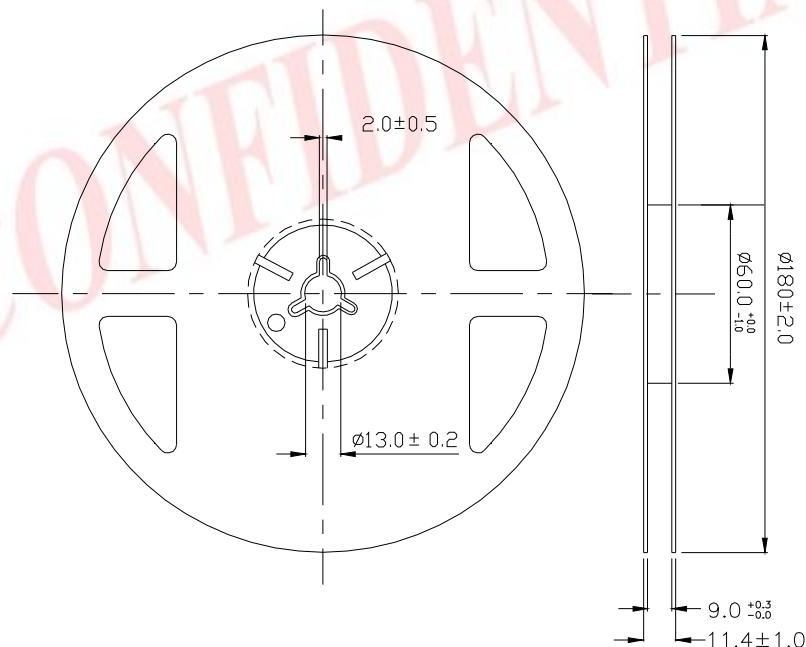
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

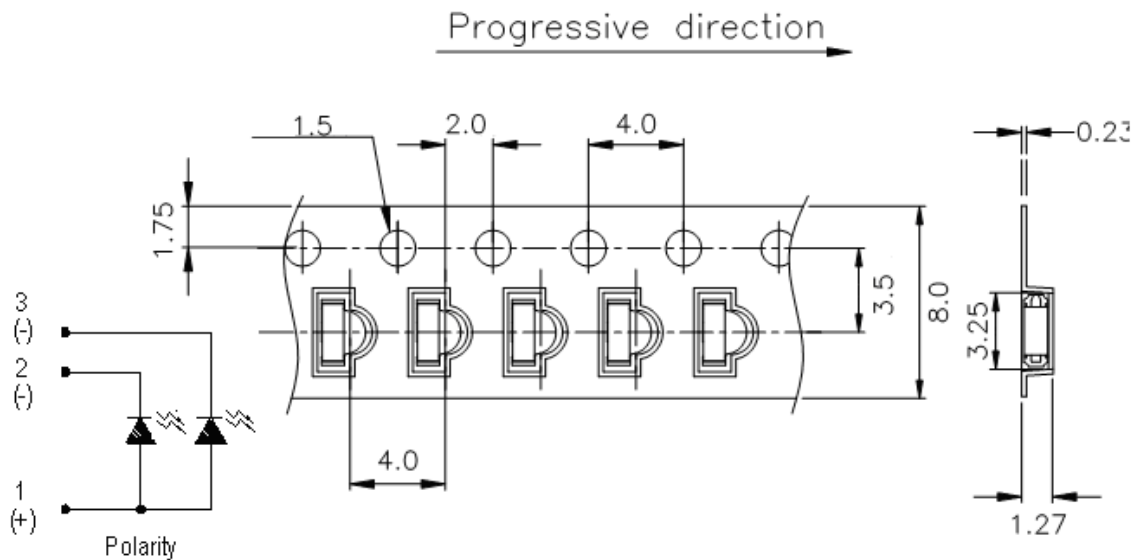


Reel Dimensions



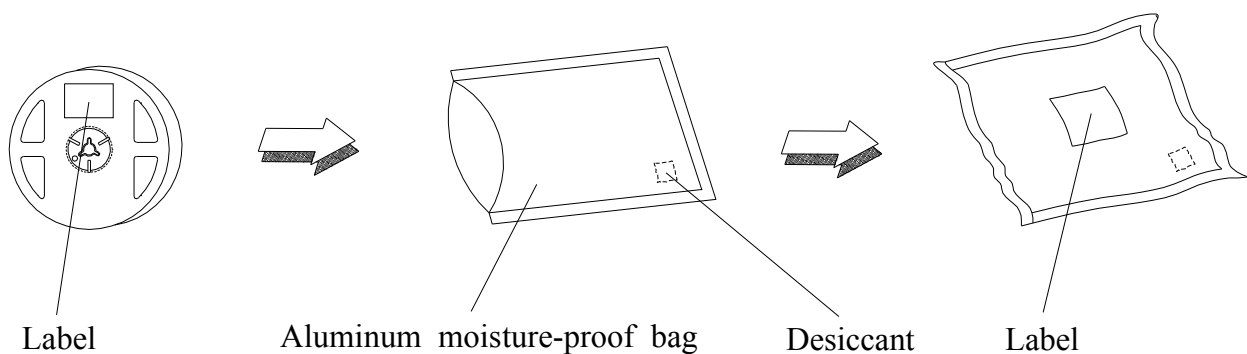
Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260 ±5 Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100 15min ∫ 5 min L : -40 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100 5min ∫ 10 sec L : -10 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I _F = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85 / 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30 °C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 1 year under 30 °C or less and 60% RH or less.

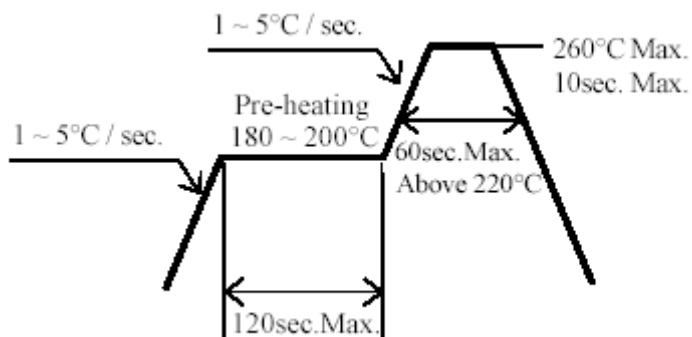
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5 °C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

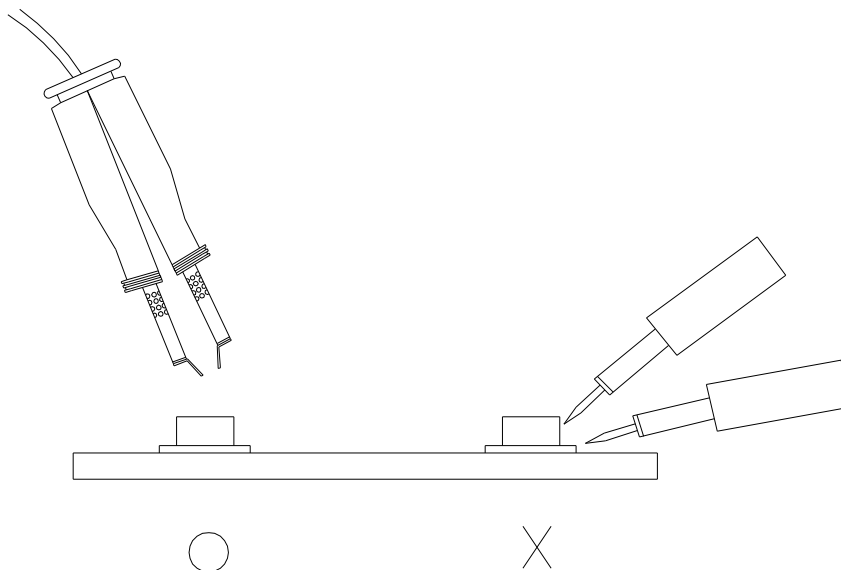
12-22SUGC/S530-A3/TR8

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd,
Tucheng, Taipei 236, Taiwan, R.O.C

Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

<http://www.everlight.com>